

Title (en)  
DEVICE FOR THE HEAT TREATMENT OF WORKPIECES

Title (de)  
VORRICHTUNG ZUR THERMISCHEN BEHANDLUNG VON WERKSTÜCKEN

Title (fr)  
DISPOSITIF DE TRAITEMENT THERMIQUE DE PIÈCES

Publication  
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Application  
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Abstract (en)  
[origin: US2011117513A1] The invention relates to a device for the thermal treatment of workpieces, in particular printed circuit boards or the like equipped with electrical and electronic components, said device comprising a process chamber (1) in which there is formed or arranged at least one heating zone or cooling zone which has a heating device or a cooling device and through which the workpieces are transported along a transporting section while being heated or cooled, wherein a pressurized gaseous fluid can be introduced into the heating zone or the cooling zone via inflow openings (18).

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Citation (examination)  

- JP 2002016352 A 20020118 - MATSUSHITA ELECTRIC IND CO LTD
- JP 2004235381 A 20040819 - SONY CORP

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